- Meets or Exceeds the Requirements of ANSI TIA/EIA-644-1995 Standard
- Signaling Rates up to 155 Mbps
- Operates From a Single 3.3-V Supply
- Low-Voltage Differential Signaling With Typical Output Voltages of 350 mV and a 100 Ω Load
- LVTTL Input Levels are 5 V Tolerant
- Driver is High Impedance When Disabled or With V_{CC} < 1.5 V
- Receiver has Open-Circuit Fail Safe
- Surface-Mount PackagingD Package (SOIC)
- Characterized For Operation From 0°C to 70°C

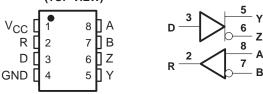
description

The SN75LVDS179, SN75LVDS180, SN75LVDS050, and SN75LVDS051 are differential line drivers and receivers that use low-voltage differential signaling (LVDS) to achieve signaling rates as high as 155 Mbps. The TIA/EIA-644 standard compliant electrical interface provides a minimum differential output voltage magnitude of 247 mV into a 100 Ω load and receipt of 100 mV signals with up to 1 V of ground potential difference between a transmitter and receiver.

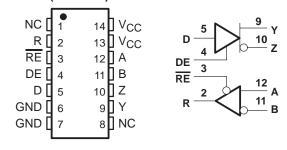
The intended application of this device and signaling technique is for point-to-point baseband data transmission over controlled impedance media of approximately $100~\Omega$ characteristic impedance. The transmission media may be printed-circuit board traces, backplanes, or cables. (Note: The ultimate rate and distance of data transfer is dependent upon the attenuation characteristics of the media, the noise coupling to the environment, and other application specific characteristics).

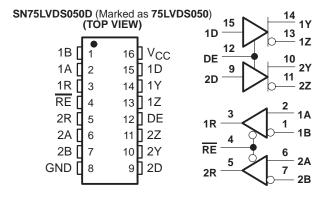
The SN75LVDS179, SN75LVDS180, SN75LVDS050, and SN75LVDS051 are characterized for operation from 0°C to 70°C.

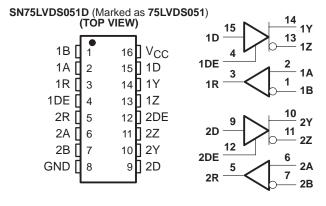
SN75LVDS179D (Marked as DS179 or 7LS179) (TOP VIEW)



SN75LVDS180D (Marked as 7LVDS180) (TOP VIEW)









Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



Function Tables

SN75LVDS179 RECEIVER

INPUTS	OUTPUT
$V_{ID} = V_A - V_B$	R
V _{ID} ≥ 100 mV	Н
-100 MV < V _{ID} < 100 mV	?
V _{ID} ≤ −100 mV	L
Open	Н

H = high level, L = low level, ? = indeterminate

SN75LVDS179 DRIVER

INPUT	OUTPUTS			
D	Υ	Z		
L	L	Н		
Н	Н	L		
Open	L	Н		

H = high level, L = low level

SN75LVDS180, SN75LVDS050, and SN75LVDS051 RECEIVER

INPUTS	OUTPUT	
$V_{ID} = V_A - V_B$	RE	R
$V_{ID} \ge 100 \text{ mV}$	L	Н
-100 MV < V _{ID} < 100 mV	L	?
$V_{ID} \le -100 \text{ mV}$	L	L
Open	L	Н
X	Н	Z

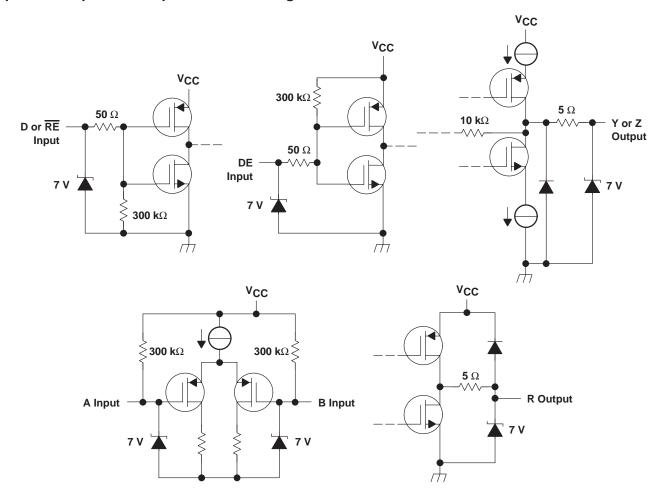
H = high level, L = low level, Z = high impedance, X = don't care

SN75LVDS180, SN75LVDS050, and SN75LVDS051 DRIVER

INPU	JTS	OUTF	PUTS
D	DE	Υ	Z
L	Н	L	Н
Н	Н	Н	L
Open	Н	L	Н
Χ	L	Z	Z

H = high level, L = low level, Z = high impedance, X = don't care

equivalent input and output schematic diagrams



SN75LVDS179, SN75LVDS180, SN75LVDS050, SN75LVDS051 HIGH-SPEED DIFFERENTIAL LINE DRIVERS AND RECEIVERS

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absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

Supply voltage range, V _{CC} (see Note 1)	0.5 V to 4 V
Voltage range (D, R, DE, RE)	–0.5 V to 6 V
Continuous power dissipation	see dissipation rating table
Storage temperature range	–65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	250°C

DISSIPATION RATING TABLE

PACKAGE	$T_{\mbox{\scriptsize A}} \le 25^{\circ}\mbox{\scriptsize C}$ POWER RATING	DERATING FACTOR ABOVE T _A = 25°C [†]	T _A = 70°C POWER RATING		
D8	725 mW	5.8 mW/°C	464 mW		
D14 or D16	950 mW	7.8 mW/°C	608 mW		

[†] This is the inverse of the junction-to-ambient thermal resistance when board-mounted and with no air flow.

recommended operating conditions

	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}	3	3.3	3.6	V
High-level input voltage, VIH	2			V
Low-level input voltage, V _{IL}			0.8	V
Magnitude of differential input voltage, V _{ID}	0.1		0.6	V
Common-mode input voltage, V _{IC} (see Figure 6)	$\frac{\left V_{ID}\right }{2}$		$\frac{ V_{ID} }{V_{CC}=0.8}$	V
Operating free–air temperature, T _A	0		70	°C



[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except differential I/O bus voltages are with respect to network ground terminal.

^{2.} Tested in accordance with MIL-STD-883C Method 3015.7.

SN75LVDS179, SN75LVDS180, SN75LVDS050, SN75LVDS051 HIGH-SPEED DIFFERENTIAL LINE DRIVERS AND RECEIVERS

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device electrical characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER		TER	TEST CONDITIONS	MIN	TYP [†]	MAX	UNIT
		SN75LVDS179	No receiver load, driver $R_L = 100 \Omega$		9	12	mA
			Driver and receiver enabled, No receiver load, Driver R_L = 100 Ω		9	12	
	SN75LVDS180	Driver enabled, receiver disabled, $R_L = 100 \Omega$		5	7	mA	
		Supply current Disabled Supply current Drivers and receivers endriver $R_L = 100 \Omega$ SN75LVDS050 Drivers enabled, receivers	Driver disabled, receiver enabled, No load		1.5	2	
			Disabled		0.5	1	
ICC	Supply current		Drivers and receivers enabled, no receiver loads, Driver R _L = 100 Ω		12	20	
			Drivers enabled, receivers disabled, $R_L = 100 \Omega$		10	16	mA
			Drivers disabled, receivers enabled, no loads		3	6	
			Disabled		0.5	1	
		SN75LVDS051	Drivers enabled, no receiver loads, driver $R_L = 100 \Omega$		12	20	mA
		31473LVD3031	Drivers disabled, No loads		3	6	IIIA

[†] All typical values are at 25°C and with a 3.3-V supply.

driver electrical characteristics over recommended operating conditions (unless otherwise noted)

	PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
IV _{OD} I	Differential output voltage magnitude		P 1000	247	340	454	
Δ V _{OD}	Change in differential output voltage magnitude betwee states	een logic	$R_L = 100Ω$, See Figure 1 and Figure 2	-50		50	mV
Voc(ss)	Steady-state common-mode output voltage			1.125	1.2	1.375	V
ΔV _{OC} (SS)	Change in steady-state common-mode output voltage logic states	between	See Figure 3			50	mV
VOC(PP)	Peak-to-peak common-mode output voltage				50	150	mV
l	High-level input current	DE	\\ = 5 \\		-0.5	-20	μΑ
lіН	riigir-ievei iripat carrent	D	− V _{IH} = 5 V		2	20	μΑ
1	Low lovel input ourrent	DE	V _{II} = 0.8 V		-0.5	-10	μА
١١٢	Low-level input current	D	VIL = 0.0 V	2	10	μΑ	
loo	Chart aircuit autaut aurrant		VOY or $VOZ = 0$ V		3	10	mA
los	Short-circuit output current		$V_{OD} = 0 V$		3	10	IIIA
la-	High impodence output output		V _{OD} = 600 mV			±1	^
loz	High-impedance output current		VO = 0 V or VCC			±1	μΑ
lO(OFF)	Power-off output current		$V_{CC} = 0 \text{ V}, V_{O} = 3.6 \text{ V}$			±1	μΑ
C _{IN}	Input capacitance				3		pF

SN75LVDS179, SN75LVDS180, SN75LVDS050, SN75LVDS051 HIGH-SPEED DIFFERENTIAL LINE DRIVERS AND RECEIVERS

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receiver electrical characteristics over recommended operating conditions (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP [†]	MAX	UNIT
V _{ITH+}	Positive-going differential input voltage threshold	See Figure 5 and Table 1			100	mV
V _{ITH} _	Negative-going differential input voltage threshold	See Figure 5 and Table 1	-100			IIIV
VOH	High-level output voltage	$I_{OH} = -8 \text{ mA}$	2.4			V
VOL	Low-level output voltage	I _{OL} = 8 mA			0.4	V
1.	Input current (A or B inputs)	V _I = 0	-2	-11	-20	μА
''	input current (A or B inputs)	V _I = 2.4 V	-1.2	-3		μΑ
I _I (OFF)	Power-off input current (A or B inputs)	$V_{CC} = 0$			±20	μΑ
ΙН	High-level input current (enables)	V _{IH} = 5 V			±10	μΑ
Ι _Ι L	Low-level input current (enables)	V _{IL} = 0.8 V			±10	μΑ
loz	High-impedance output current	V _O = 0 or 5 V			±10	μΑ
Cl	Input capacitance			5	·	pF

[†] All typical values are at 25°C and with a 3.3-V supply.

driver switching characteristics over recommended operating conditions (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN TYPT	MAX	UNIT
tPLH	Propagation delay time, low-to-high-level output			6	ns
tPHL	Propagation delay time, high-to-low-level output			6	ns
t _r	Differential output signal rise time	$R_L = 100\Omega$,	0.8	1.2	ns
t _f	Differential output signal fall time	$C_L = 10 pF$,	0.8	1.2	ns
t _{sk(p)}	Pulse skew (t _{pHL} - t _{pLH}) [‡]	See Figure 6		0.6	ps
t _{sk(o)}	Channel-to-channel output skew§			0.6	ps
tsk(pp)	Part-to-part skew¶			1	ps
^t PZH	Propagation delay time, high-impedance-to-high-level output			25	ns
tPZL	Propagation delay time, high-impedance-to-low-level output	Coo Figure 7		25	ns
tPHZ	Propagation delay time, high-level-to-high-impedance output	See Figure 7		25	ns
^t pLZ	Propagation delay time, low-level-to-high-impedance output			25	ns

[†] All typical values are at 25°C and with a 3.3-V supply.

[‡] t_{sk(p)} is the magnitude of the time difference between the high-to-low and low-to-high propagation delay times at an output

 $[\]S$ $t_{sk(o)}$ is the magnitude of the time difference between the outputs of a single device with all of their inputs connected together.

[¶] tsk(pp) is the magnitude of the difference in propagation delay times between any specified terminals of two devices when both devices operate with the same supply voltages, same temperature, and have identical packages and test circuits.

receiver switching characteristics over recommended operating conditions (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
tPLH	Propagation delay time, low-to-high-level output			2.1	6	ns
tPHL	Propagation delay time, high-to-low-level output	C _L = 10 pF, See Figure 6		2.1	6	ns
t _r	Output signal rise time			0.6	1.5	ns
t _f	Output signal fall time			0.7	1.5	ns
t _{sk(p)}	Pulse skew (t _{pHL} - t _{pLH}) [‡]				0.6	ns
t _{sk(o)}	Channel-to-channel output skew§				0.6	ns
t _{sk(pp)}	Part-to-part skew¶				1	ns
^t PZH	Propagation delay time, high-level-to-high-impedance output				25	ns
tPZL	Propagation delay time, low-level-to-low-impedance output	Soo Figure 7			25	ns
^t PHZ	Propagation delay time, high-impedance-to-high-level output	See Figure 7			25	ns
tPLZ	Propagation delay time, low-impedance-to-high-level output				25	ns

[†] All typical values are at 25°C and with a 3.3-V supply.

PARAMETER MEASUREMENT INFORMATION

driver

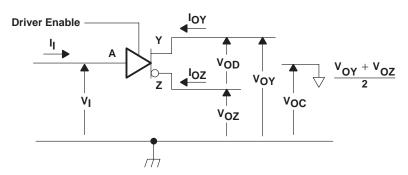


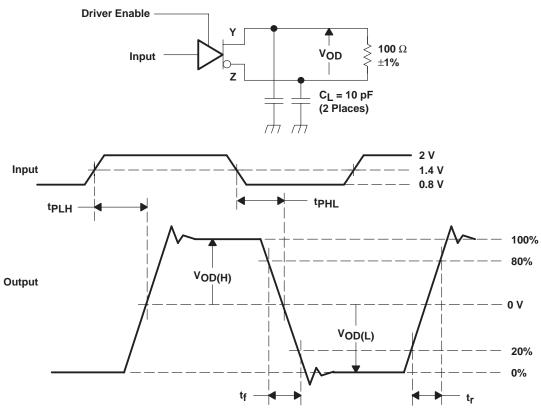
Figure 1. Driver Voltage and Current Definitions

 $^{^{\}ddagger}$ $t_{Sk(p)}$ is the magnitude of the time difference between the high-to-low and low-to-high propagation delay times at an output

[‡]t_{sk(o)} is the magnitude of the time difference between the outputs of a single device with all of their inputs connected together.

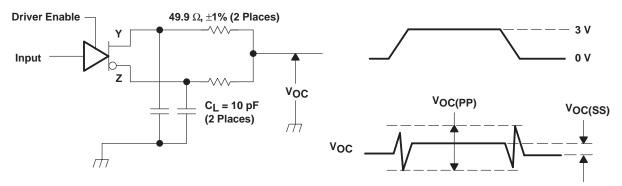
[‡] t_{sk(o)} is the magnitude of the difference in propagation delay times between any specified terminals of two devices when both devices operate with the same supply voltages, same temperature, and have identical packages and test circuits.

driver (continued)



NOTE A: All input pulses are supplied by a generator having the following characteristics: t_{Γ} or $t_{\Gamma} \le 1$ ns, pulse repetition rate (PRR) = 50 Mpps, pulse width = 10 ± 0.2 ns . C_{L} includes instrumentation and fixture capacitance within 0,06 mm of the D.U.T.

Figure 2. Test Circuit, Timing, and Voltage Definitions for the Differential Output Signal

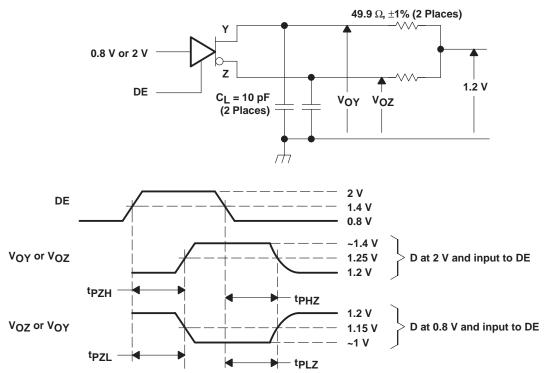


NOTE A: All input pulses are supplied by a generator having the following characteristics: t_r or $t_f \le 1$ ns, pulse repetition rate (PRR) = 50 Mpps, pulse width = 10 ± 0.2 ns. C_L includes instrumentation and fixture capacitance within 0,06 mm of the D.U.T. The measurement of $V_{OC(PP)}$ is made on test equipment with a -3 dB bandwidth of at least 300 MHz.

Figure 3. Test Circuit and Definitions for the Driver Common-Mode Output Voltage



driver (continued)



NOTE A: All input pulses are supplied by a generator having the following characteristics: t_f or $t_f \le 1$ ns, pulse repetition rate (PRR) = 0.5 Mpps, pulse width = 500 ± 10 ns . C_1 includes instrumentation and fixture capacitance within 0,06 mm of the D.U.T.

Figure 4. Enable and Disable Time Circuit and Definitions

PARAMETER MEASUREMENT INFORMATION

receiver

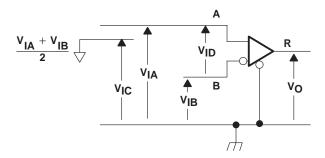
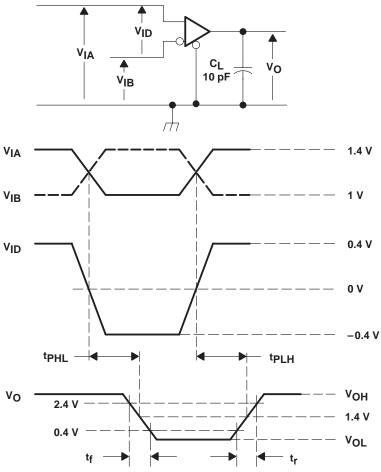


Figure 5. Receiver Voltage Definitions

Table 1. Receiver Minimum and Maximum Input Threshold Test Voltages

APPLIED VOLTAGES (V)		RESULTING DIFFERENTIAL INPUT VOLTAGE (mV)	RESULTING COMMON- MODE INPUT VOLTAGE (V)		
VIA	V _{IB}	V _{ID}	V _{IC}		
1.25	1.15	100	1.2		
1.15	1.25	-100	1.2		
2.4	2.3	100	2.35		
2.3	2.4	-100	2.35		
0.1	0	100	0.05		
0	0.1	-100	0.05		
1.5	0.9	600	1.2		
0.9	1.5	-600	1.2		
2.4	1.8	600	2.1		
1.8	2.4	-600	2.1		
0.6	0	600	0.3		
0	0.6	-600	0.3		

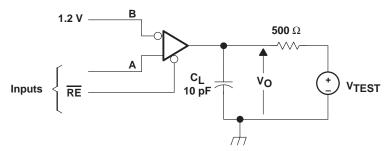
receiver (continued)



NOTE A: All input pulses are supplied by a generator having the following characteristics: t_{Γ} or $t_{f} \le 1$ ns, pulse repetition rate (PRR) = 50 Mpps, pulse width = 10 ± 0.2 ns. C_{L} includes instrumentation and fixture capacitance within 0,06 m of the D.U.T.

Figure 6. Timing Test Circuit and Waveforms

receiver (continued)



NOTE A: All input pulses are supplied by a generator having the following characteristics: t_f or $t_f \le 1$ ns, pulse repetition rate (PRR) = 0.5 Mpps, pulse width = 500 ± 10 ns. C_L includes instrumentation and fixture capacitance within 0,06 m of the D.U.T.

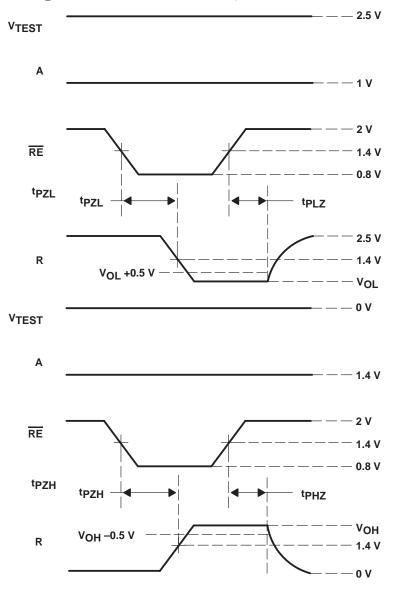


Figure 7. Enable/Disable Time Test Circuit and Waveforms



TYPICAL CHARACTERISTICS

COMMON-MODE INPUT VOLTAGE vs DIFFERENTIAL INPUT VOLTAGE

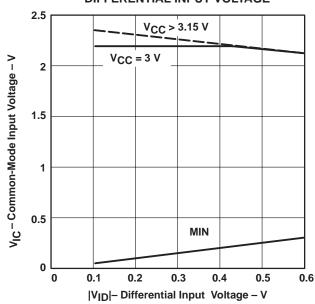
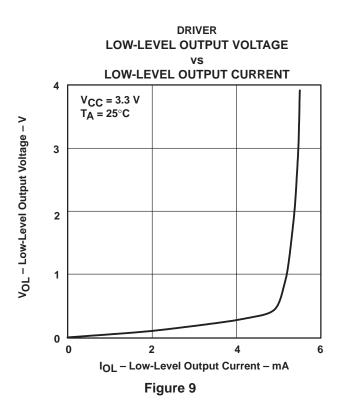
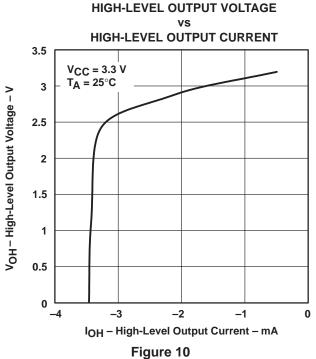


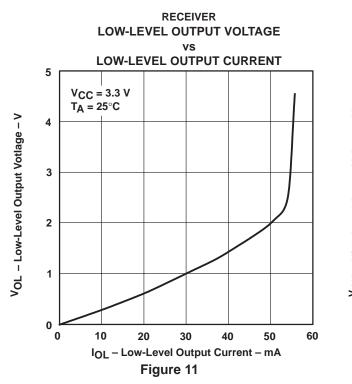
Figure 8

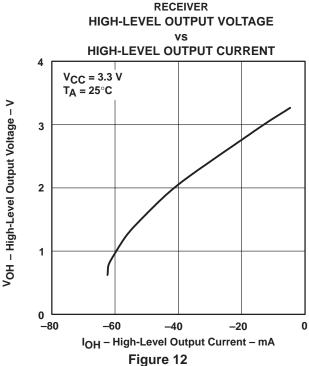




DRIVER

TYPICAL CHARACTERISTICS





APPLICATION INFORMATION

The devices are generally used as building blocks for high-speed point-to-point data transmission. Ground differences are less than 1 V with a low common—mode output and balanced interface for very low noise emissions. Devices can interoperate with RS-422, PECL, and IEEE-P1596. Drivers/Receivers maintain ECL speeds without the power and dual supply requirements.

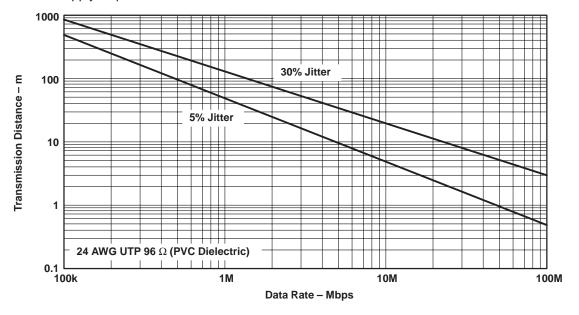


Figure 13. Data Transmission Distance Versus Rate

APPLICATION INFORMATION

fail safe

One of the most common problems with differential signaling applications is how the system responds when no differential voltage is present on the signal pair. The LVDS receiver is like most differential line receivers, in that its output logic state can be indeterminate when the differential input voltage is between –100 mV and 100 mV and within its recommended input common-mode voltage range. TI's LVDS receiver is different in how it handles the open-input circuit situation, however.

Open-circuit means that there is little or no input current to the receiver from the data line itself. This could be when the driver is in a high-impedance state or the cable is disconnected. When this occurs, the LVDS receiver will pull each line of the signal pair to near V_{CC} through 300-k Ω resistors as shown in Figure 14. The fail-safe feature uses an AND gate with input voltage thresholds at about 2.3 V to detect this condition and force the output to a high-level regardless of the differential input voltage.

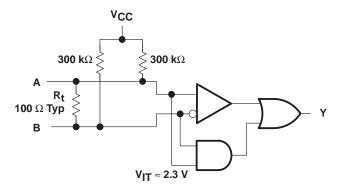


Figure 14. Open-Circuit Fail Safe of the LVDS Receiver

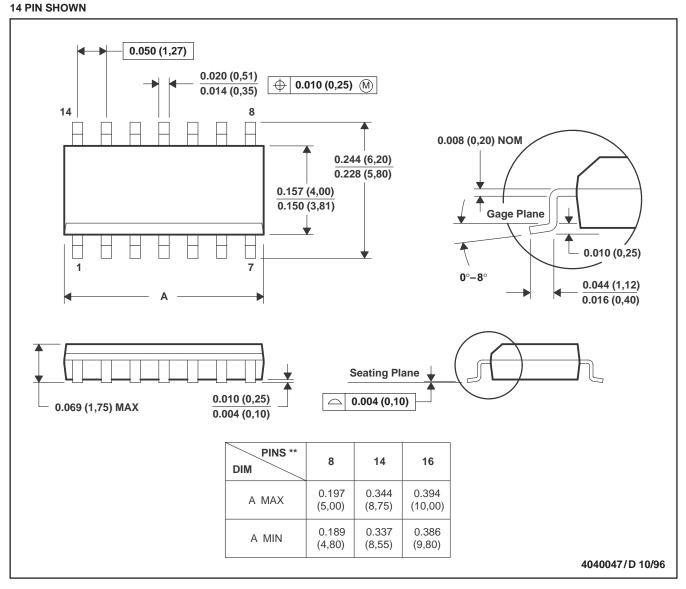
It is only under these conditions that the output of the receiver will be valid with less than a 100-mV differential input voltage magnitude. The presence of the termination resistor, Rt, does not affect the fail-safe function as long as it is connected as shown in the figure. Other termination circuits may allow a dc current to ground that could defeat the pullup currents from the receiver and the fail-safe feature.

MECHANICAL DATA

D (R-PDSO-G**)

- (.... 200 o

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012

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PACKAGING INFORMATION

Orderable part number	Status (1)	Material type	Package Pins	Package qty Carrier	RoHS	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
SN75LVDS051D	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	75LVDS051
SN75LVDS051D.B	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	75LVDS051

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

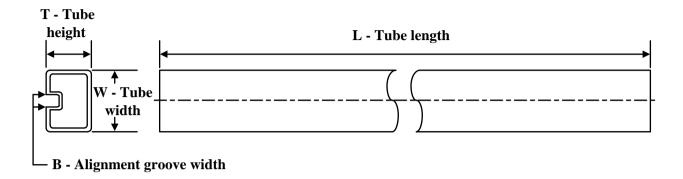
⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN75LVDS051D	D	SOIC	16	40	505.46	6.76	3810	4
SN75LVDS051D.B	D	SOIC	16	40	505.46	6.76	3810	4

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